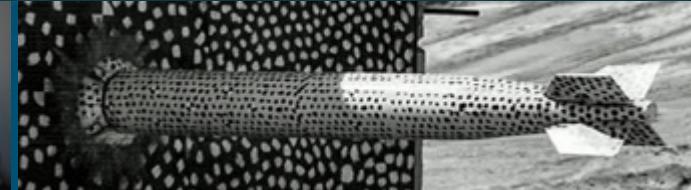
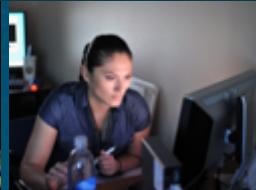




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SAND2021-6736PE |

# Component Testing, Co-Optimization, and Trade-Space Evaluation



Jason Neely

Sandia National Laboratories

June 25, 2021

Project ID: elt223

SAND2021-5947 PE

This presentation does not contain any proprietary, confidential, or otherwise restricted information



# Overview



## Timeline

- Start – FY19
- End – FY23
- 50% complete

## Budget

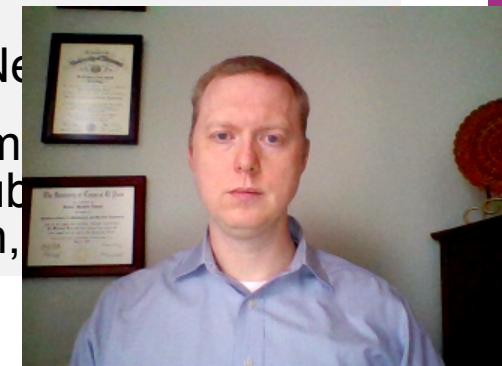
- Total project funding
  - DOE share – 100%
- Funding received in FY19: \$250k
- Funding for FY20: \$350k
- Funding for FY21: \$350k

## Goals/Barriers

- Drive System Power Density = 33 kW/L
  - Power Electronics Density = 100 kW/L
  - Motor/Generator Density = 50 kW/L
- Power target > 100 kW
- Cost target for drive system (\$6/kW)
- Operational life of drive system = 300k miles
- Design constraints include
  - Thermal limits
  - Transistor / Diode reliability
  - Capacitor reliability

## Partners

- Scott Sudhoff, Steve Pekarek – Purdue University
- Jon Wierer – Lehigh University
- Woongie Sung – State University of New York at Albany
- Project lead: Sandia Labs, Team Members: Lee Rashkin, Luke Yates, Ganesh Subramanian, Matt Flicker, Andrew Binder, Todd Monson, ...



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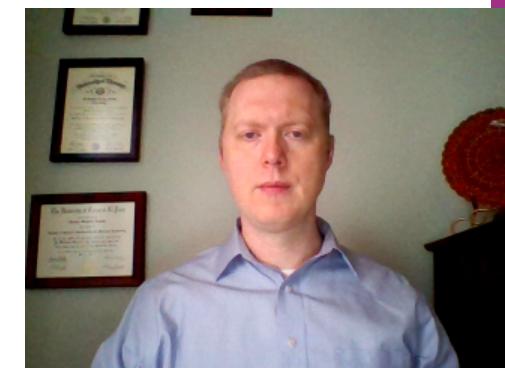
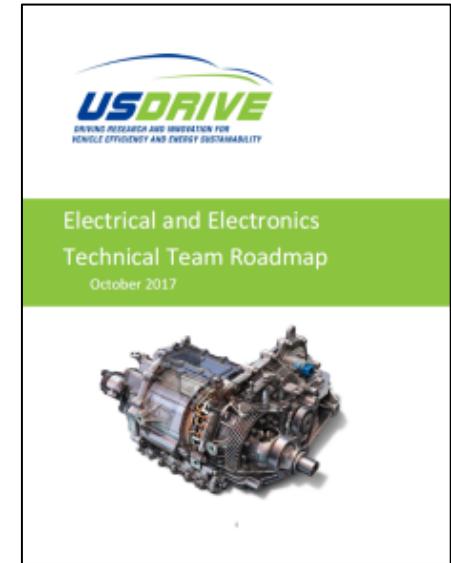
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# Relevance and Objectives



- The primary purpose of this project is to identify electric traction drive (ETD) designs, including inverter drive and electric machine, that are predicted to meet the goals outlined in the US Drive Electrical and Electronics Technical Team Roadmap [1]:
  - Power Density target for drive system = 33kW/L or a 100 kW peak system
    - Power Electronics Density = 100 kW/L
    - Electric Motor Density = 50 kW/L
  - Operational life of drive system = 300k miles
  - Cost target for drive system (\$6/kW)
- To support this design goal, this effort has four objectives
  - Evaluate options for reducing size of filter and thermal management components
  - Generate high-fidelity dimensional and electrical models for principal power electronic components within a novel inverter design
  - Demonstrate and evaluate representative converter prototypes
  - Co-Optimize inverter and machine designs for power density, reliability, and efficiency



[1] See the U.S. DRIVE Partnership Plan, at <https://www.energy.gov/eere/vehicles/downloads/us-drive-electrical-and-electronics-technical-team-roadmap>

# Approach: Distributed Bus Filter



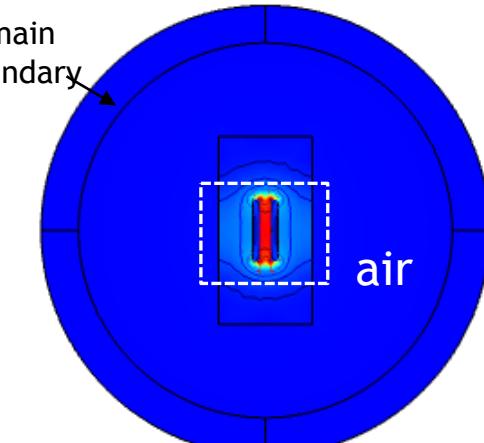
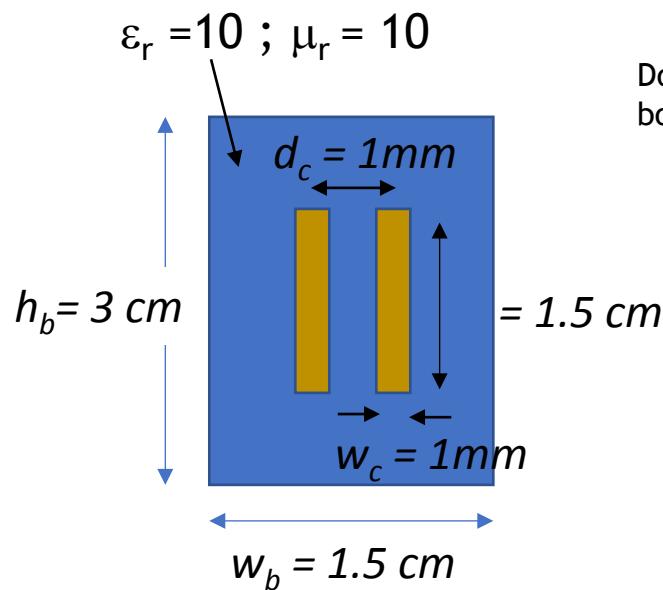
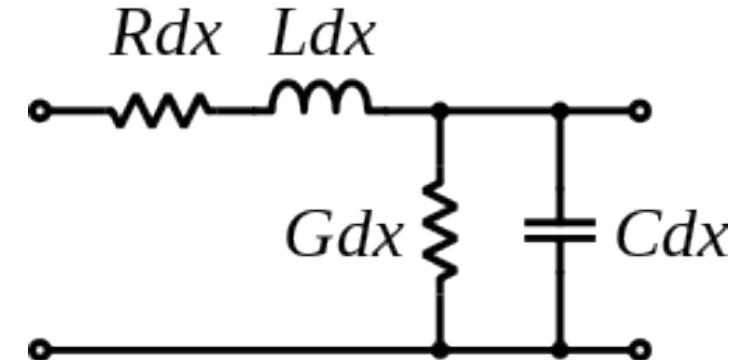
**Objective:** Evaluate options for reducing size of filter components

Can we use the distributed inductance and capacitance in the transmission bus to filter out undesired frequencies, eliminating lumped-element filter components

- Current ripple : Switching frequency is 100 kHz => target  $f_c \sim 10$  kHz
- EMI: Edge rates are  $\sim 80$  nsec => target  $f_c \sim 500$  kHz

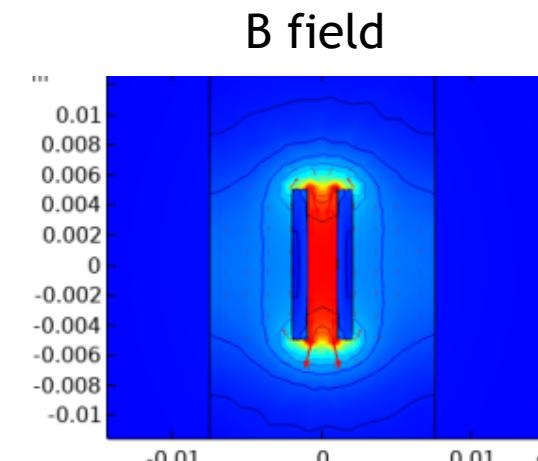
Electromagnetic simulation (COMSOL®) preliminary designs

- 2-wire system example system
- Composite background medium :  $\epsilon_r = 10$  ;  $\mu_r = 10$
- 2D and 3D models developed to estimate performance

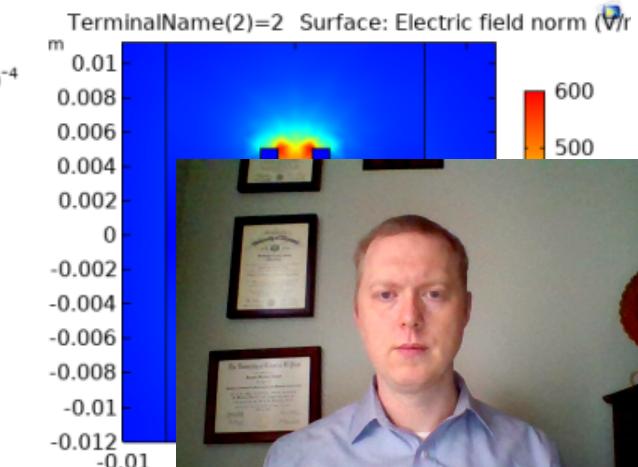


B field ( @ 1KHz)

2D simulation



B field



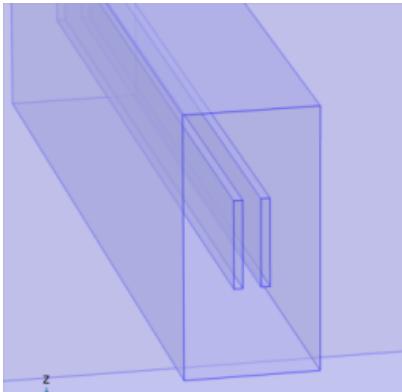
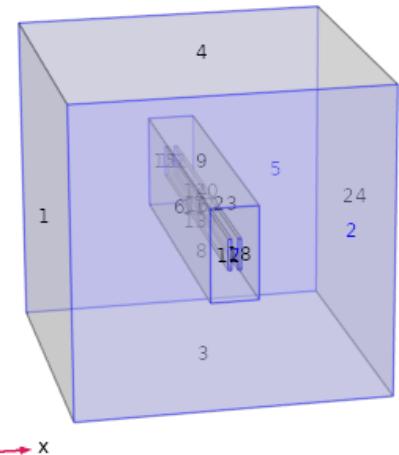
E field



# Technical Accomplishments: Distributed Bus Filter

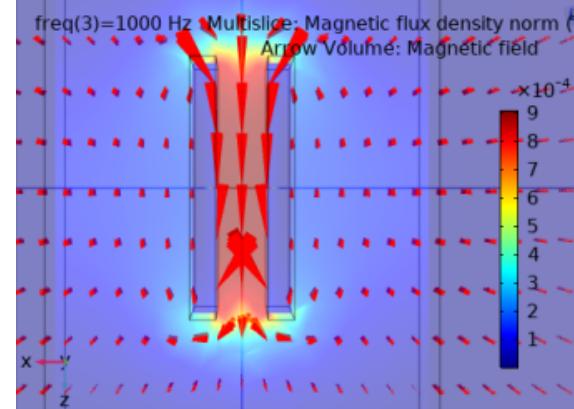


## 3D simulation

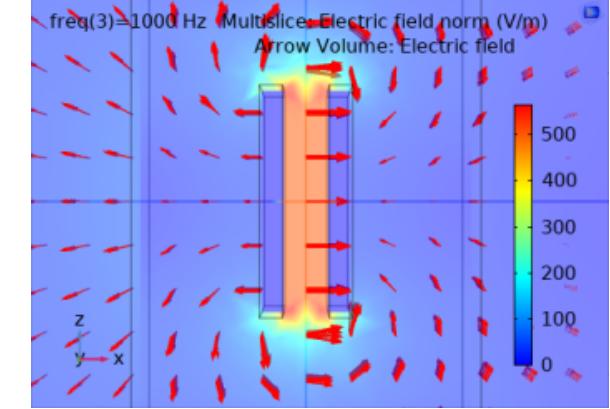


$$\begin{aligned} L &\sim 1.8 \mu\text{H/m} \\ C &\sim 588 \text{ pF/m} \end{aligned}$$

B field



E field



- 3D simulations give L,C values similar to that from 2D simulations
  - 2D simulations can be a good guide : computationally expedient
- Current values of L and C are low ( $\sim \mu\text{H/m}$  and  $\sim \text{nF/m}$ )
- Using simulation, filter cut-off frequency estimated: for  $l = 20 \text{ cm}$ ,  $f_c \sim 24.5 \text{ MHz}$
- Will explore additional geometries and multiphasic design to increase L,C

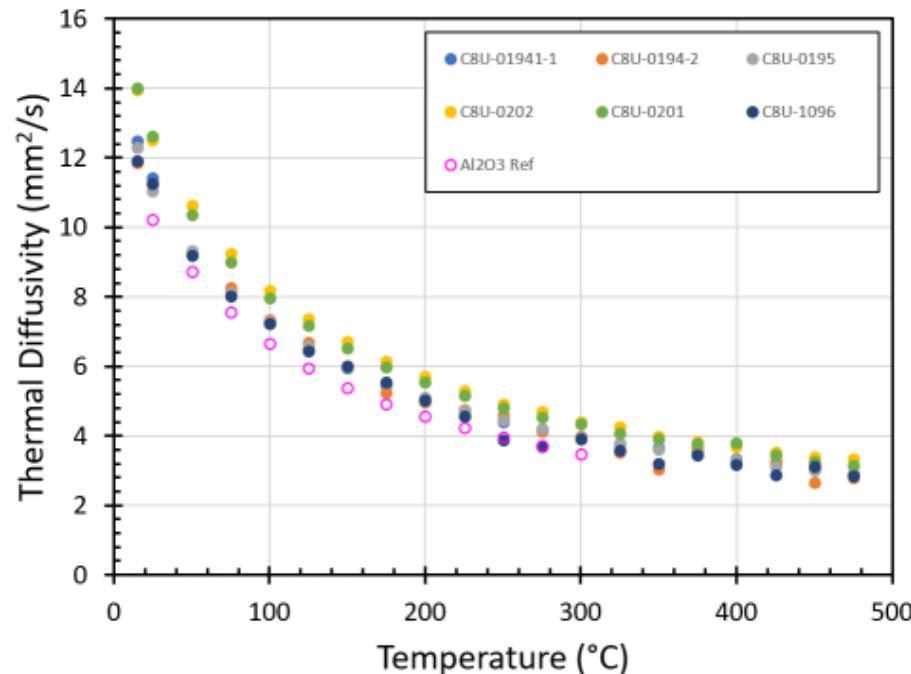


# Approach: Surround Cooling Concept



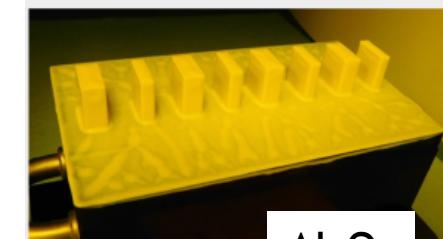
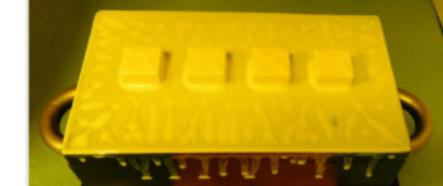
**Objective:** Evaluate options for reducing size of thermal management components

- State-of-the-art ceramic additive manufacturing technology allows for materials with exceptional thermal properties
- By surrounding or fully encasing a power device with a ceramic, heat spreading will result in reduced device temperatures.
- Features such as pin fins and cooling channels can be incorporated into the printed ceramic.
- $\text{Al}_2\text{O}_3$  samples printed by Lithoz Inc. and evaluated via flash diffusivity measurements were then fed into thermal simulations to evaluate the effectiveness of the surround cooling concept.

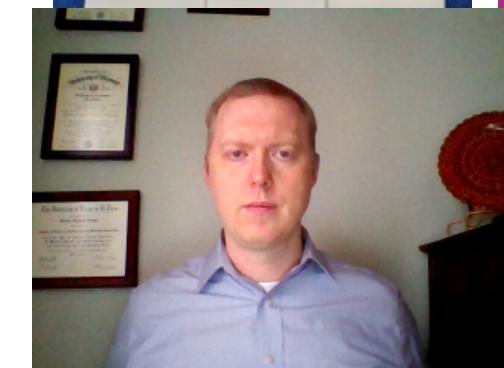


Printed  $\text{Al}_2\text{O}_3$  ceramics measured thermal conductivities ranged from: 33.5 to 38.7 W/m-K and demonstrated a linear correlation with density.

As printed



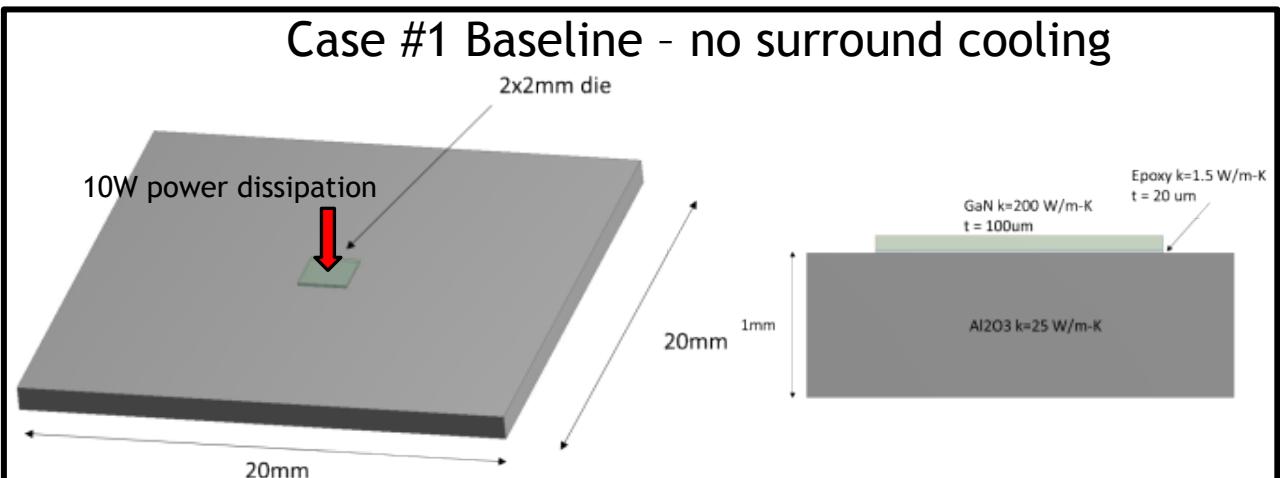
$\text{Al}_2\text{O}_3$



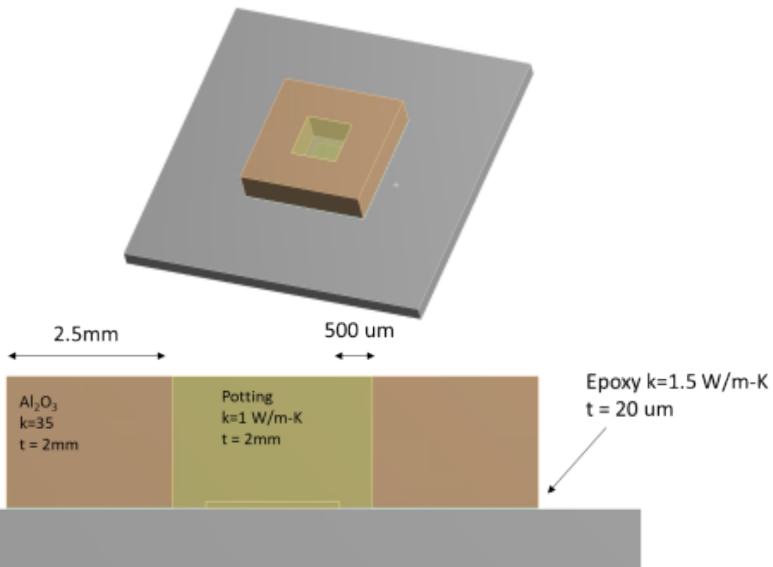
# Technical Accomplishments: Surround Cooling Simulations



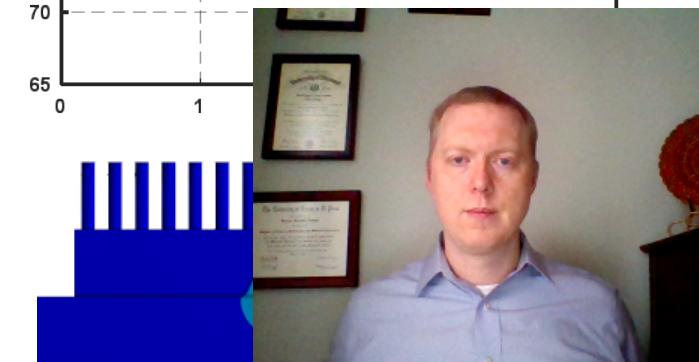
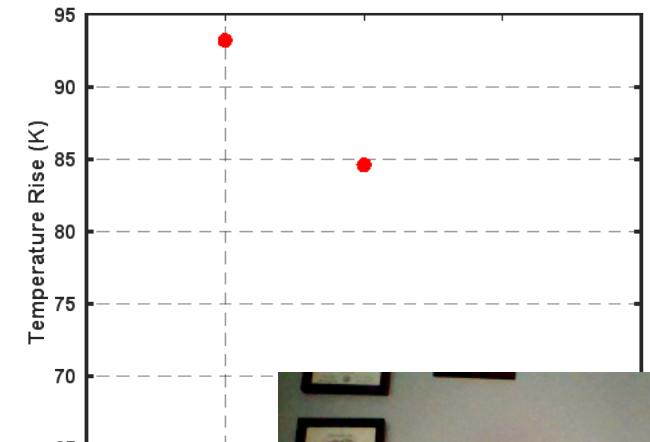
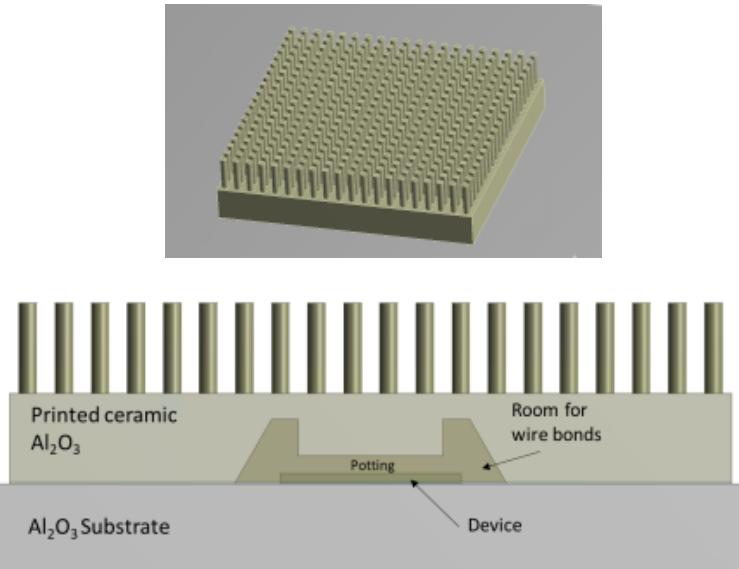
- $\text{Al}_2\text{O}_3$  3D printed ceramics can be used to surround and even encase electronic components with significant thermal loads. (high resolution features  $\sim 100 \mu\text{m}$ )
- Preliminary modeling results show a potential **29% reduction** in temperature rise for encased cooling with fins



**Case #2 Surround ceramic with potting**



**Case #3 Fully encased device with fins**



# Approach: Converter and Inverter Optimization



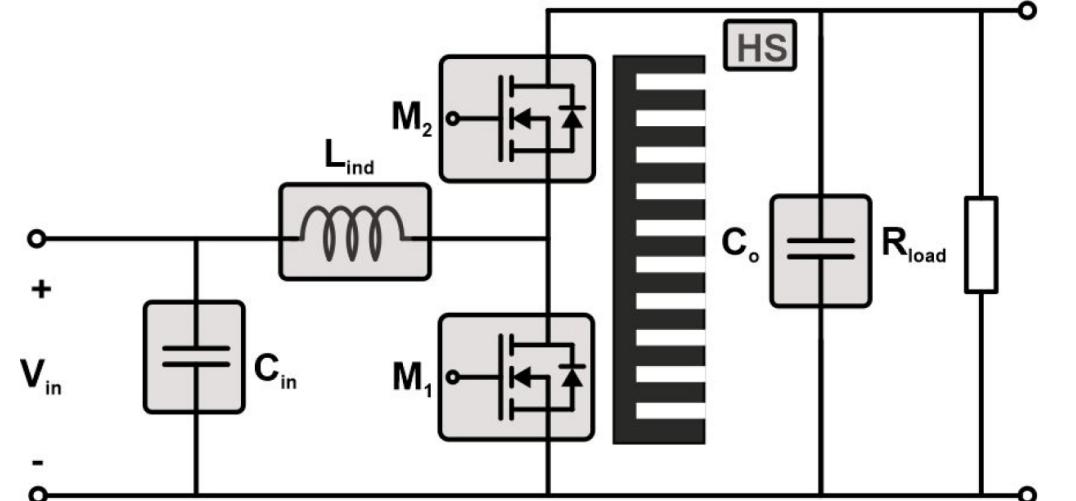
Converter optimization software exercised to optimize boost converter for power density and reliability

## Mean-Time-Between-Failure (MTBF)

- Metric to evaluate or estimate the expected lifetime of repairable items.
- Defined as the probability of an individual unit of interest, operating with full functionality for a specific length of time under specific tests or stress conditions.
- MTBF of power electronic systems requires understanding of dynamics in thermal and electrical stress on a system

## Boost Converter Parameters Affecting Reliability or MTBF and Power Density

- Input & output voltage on the input and output capacitors
- Switching frequency affects transistor switching and conductor losses, and core loss (thermal stress)
- Inductor current ripple factor affects the core size and transistor stress
- Capacitor ripple factor affects the capacitor volume and temperature of operation



$$MTBF = \frac{\text{Total System Operational time}}{\text{Total Number of Failures}}$$

Can also be represented as

$$MTBF = \frac{1}{\lambda}$$

Where

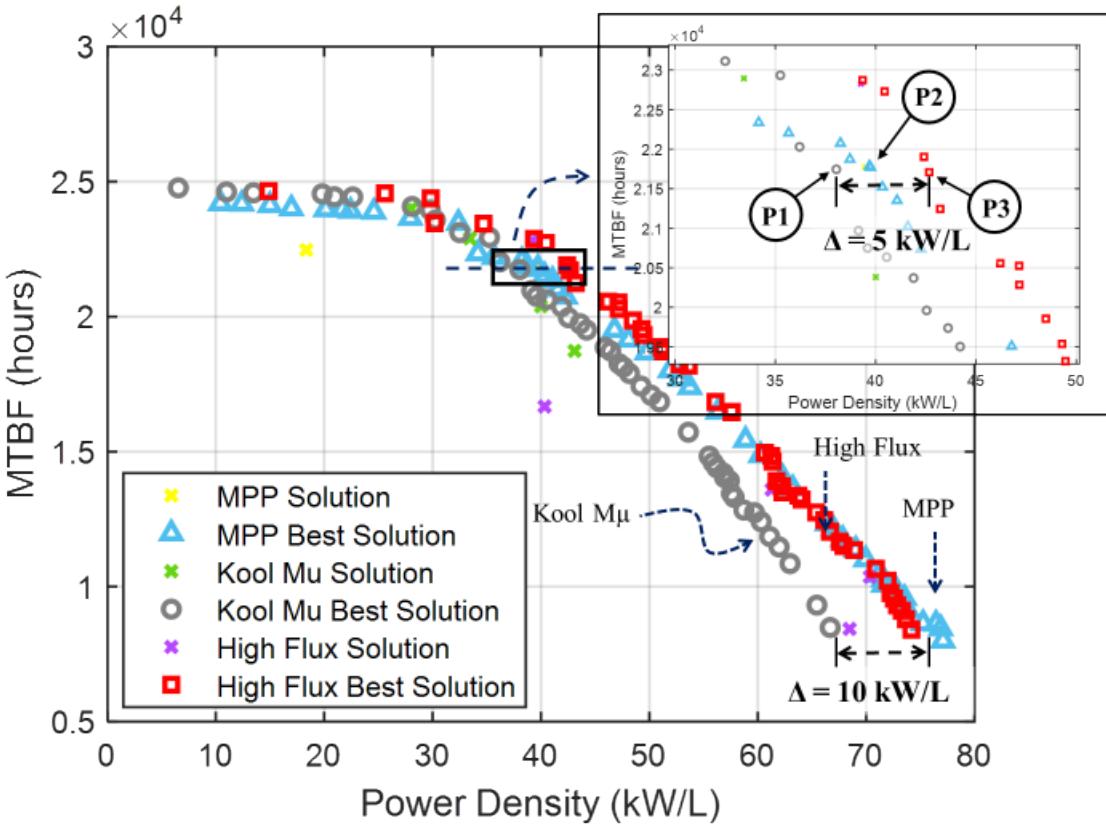
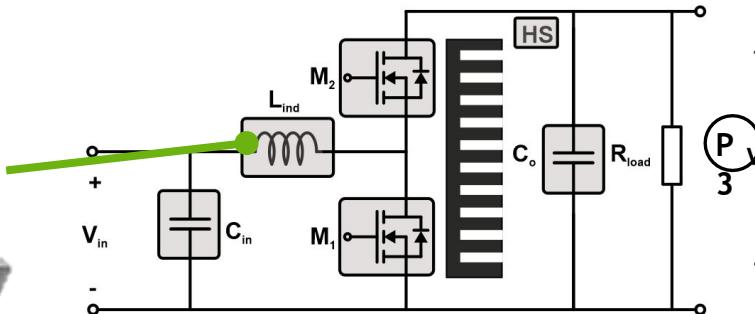
$\lambda$ : Intrinsic failure rate of a

For a given system composed of

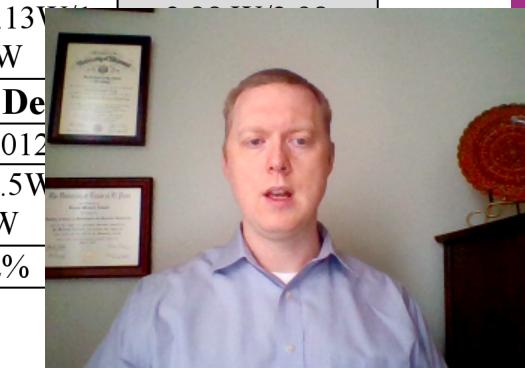
$$\lambda = \sum_{i=1}^n \lambda_i$$



# Technical Accomplishments: Boost Converter Optimization



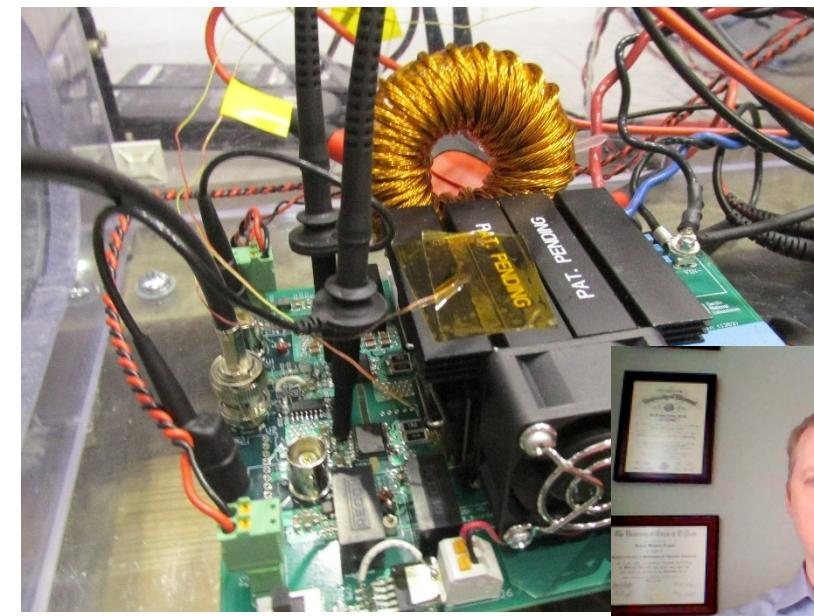
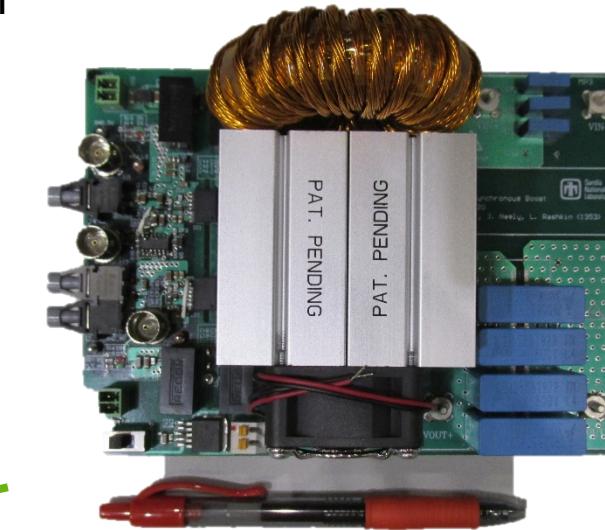
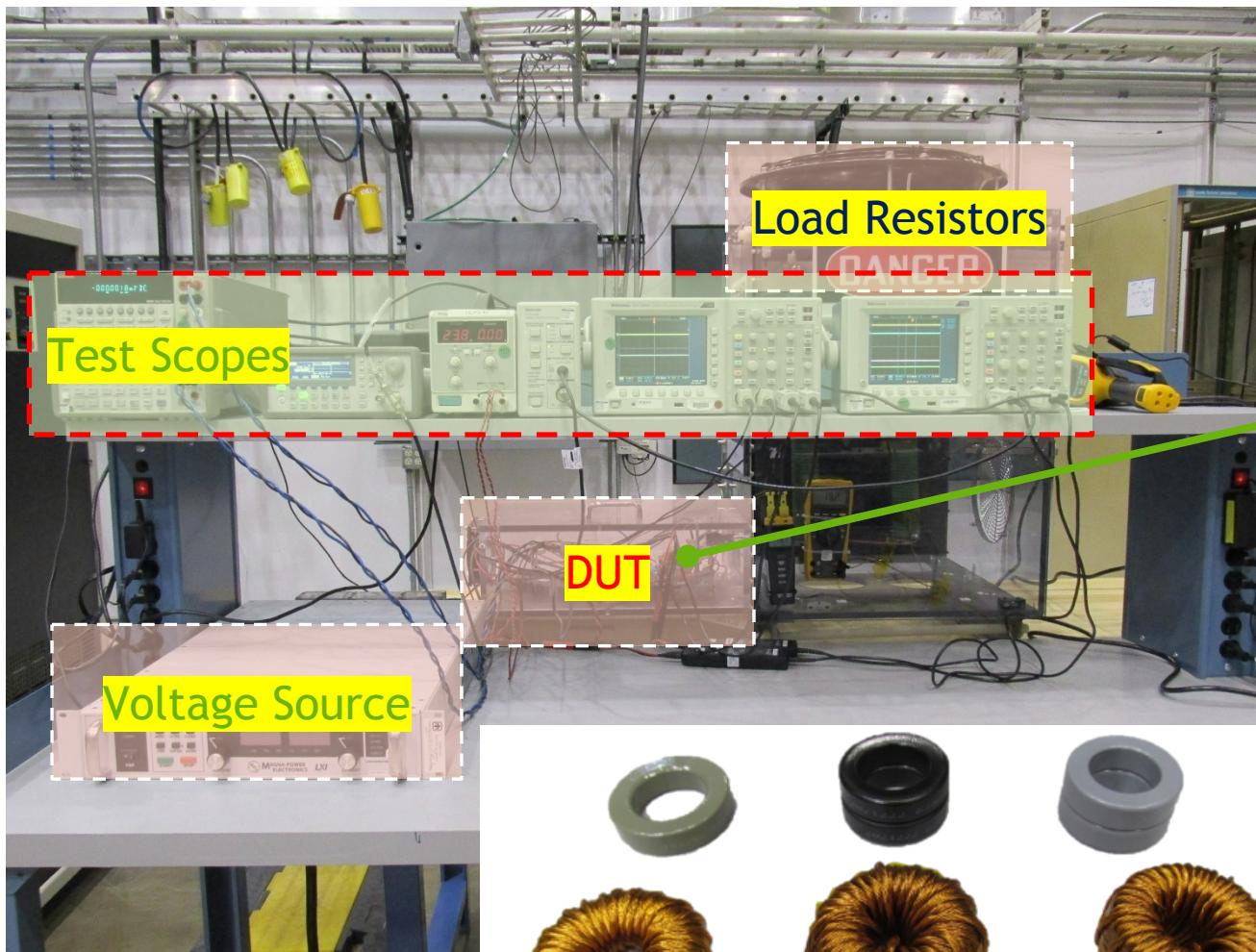
Operating Condition			
Variable	P1 (Kool M $\mu$ )	P2 (MPP)	P3 (High Flux)
Input, Vin	400V	400V	400V
Output, Vo	500V	500V	500V
$\frac{P_1}{P_2} - \frac{P_1}{P_3}$	7.47-17.78A	9.9-15.35A	10.74-14.57A
$\frac{f_1}{f_2}$	47.37 kHz	48.7 kHz	47.87 kHz
Duty Cycle	20.81%	20.8%	21.4 %
$\frac{T_1}{T_2}$	78.8°C	75.19°C	75°C
Inductance	169 $\mu$ H	310 $\mu$ H	462 $\mu$ H
Input Capacitors		Output Capacitors	
Model #	B32641B6682J	Model #	B32774X8305
Capacitance	$3 \times 6.8$ <td>Capacitance</td> <td><math>4 \times 3</math> <math>\mu</math>F</td>	Capacitance	$4 \times 3$ $\mu$ F
Boost Inductor			
AWG/Strands	23 AWG/10	23 AWG/10	23 AWG/10
Model #	0077717A7	C055716A2	C058110A2
Fill Factor	20%	17.7%	24%
Turns Number	52	46	78
Loss (W/C)	10.53W/10.8W	10.89W/7.09W	7.84 W/8.8 W
Temp. Rise	48.6 °C	35 °C	90.96 °C
Low Side Semiconductor Device			
Model #	C2M0040120D	C2M0040120D	C2M0040120D
Loss (Ton/Toff/Cond)	2.09W/3.45W/1.33W	2.69W/3.13W/1.33W	2.00W/3.00W/1.00W
High Side Semiconductor Device			
Model #	C2M0040120D	C2M0040120D	C2M0040120D
Loss (Ton/Toff/Cond)	5.82W/2.28W/0.05W	4.68W/2.5W/0.05W	5.00W/2.00W/0.05W
Total Efficiency	99.16%	99.2%	99.2%



# Technical Accomplishments: Boost Converter Optimization



- Experimental hardware was developed to represent designs from Pareto Front and validate boost converter simulation model



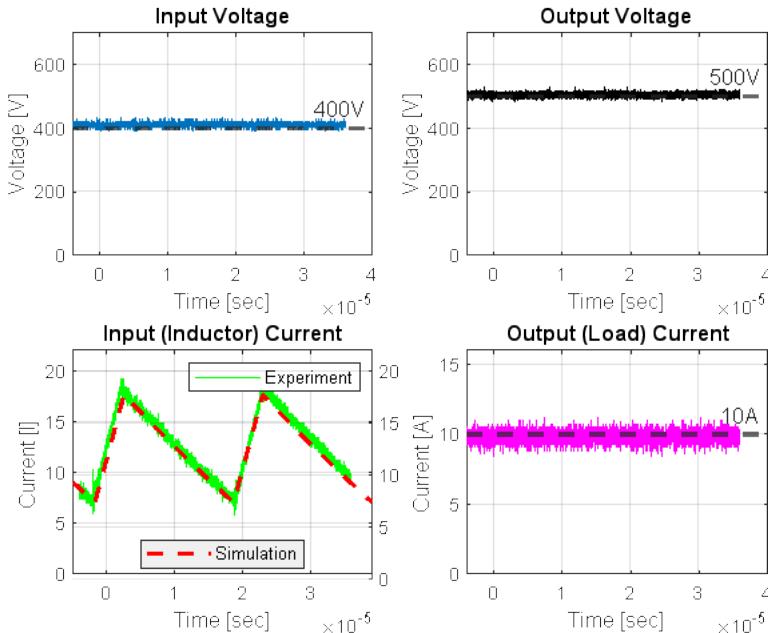
# Technical Accomplishments: Boost Converter Optimization



## Experimental Results and Simulation Comparison

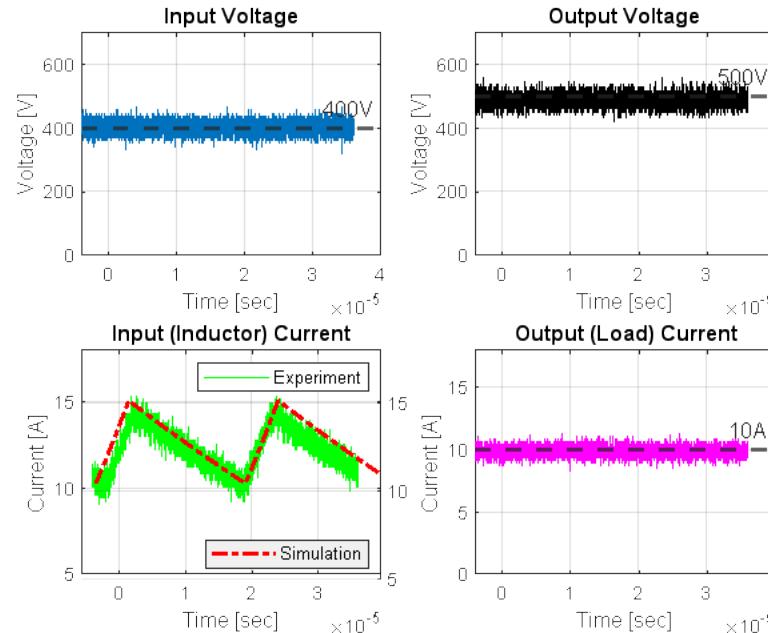
P1

Kool Mu



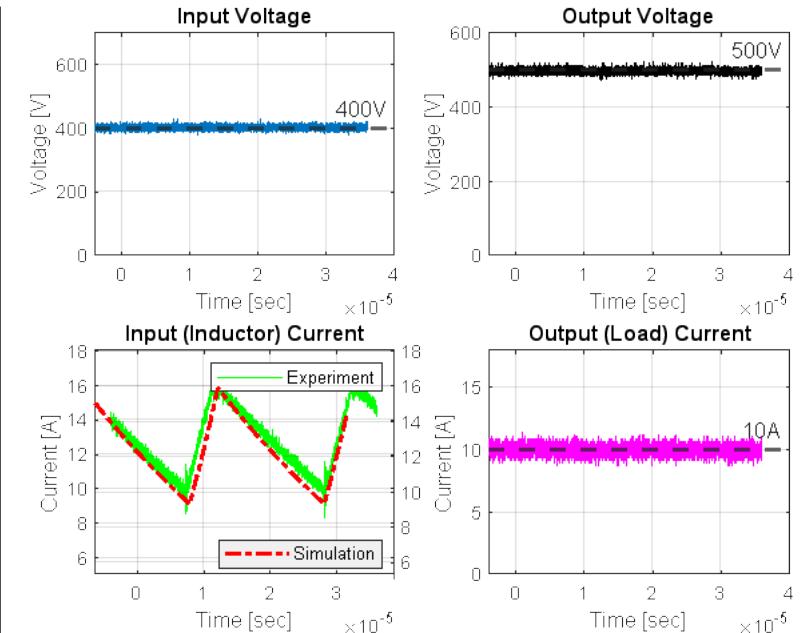
P2

MPP



P3

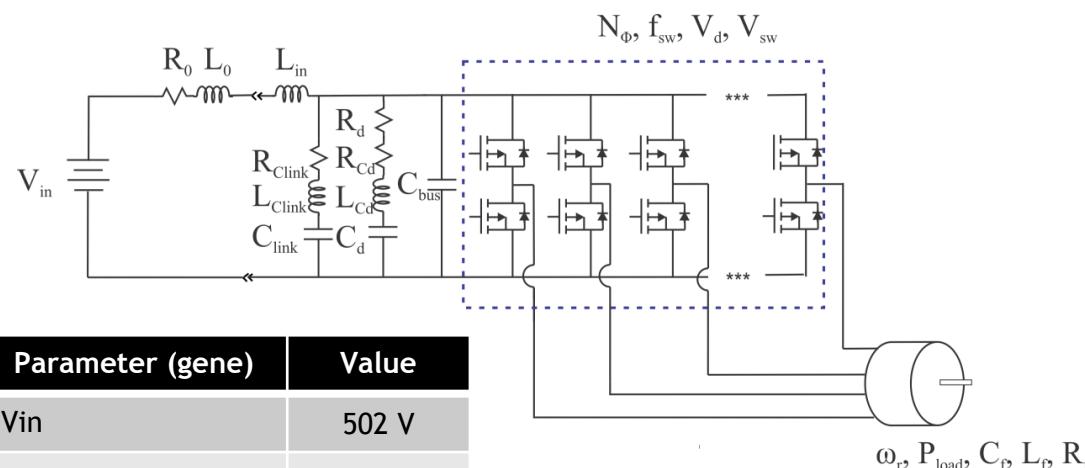
High Flux



Parameter	Estimated (P1/P2/P3)	Actual (P1/P2/P3)
Efficiency	99.16% / 99.2% / 99.2%	97% / 98.8% / 98.9%

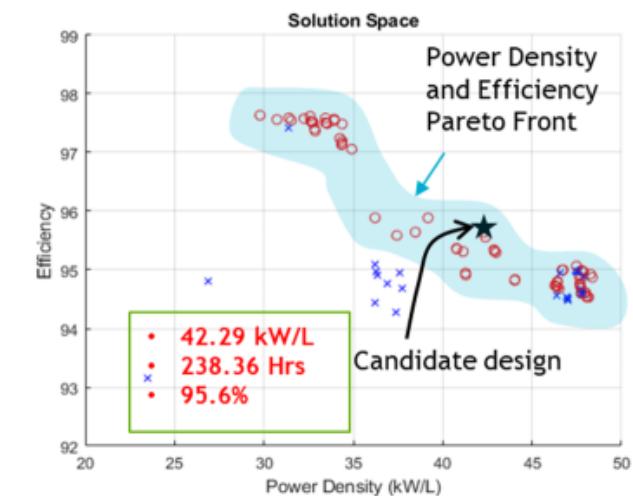
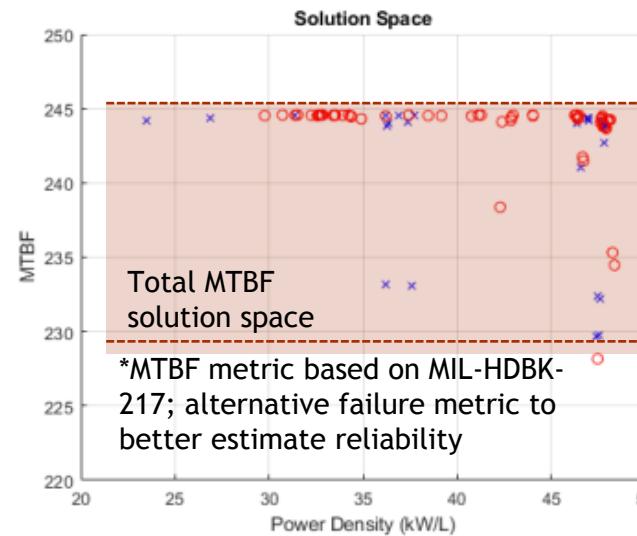


# Technical Accomplishments: Inverter Optimization

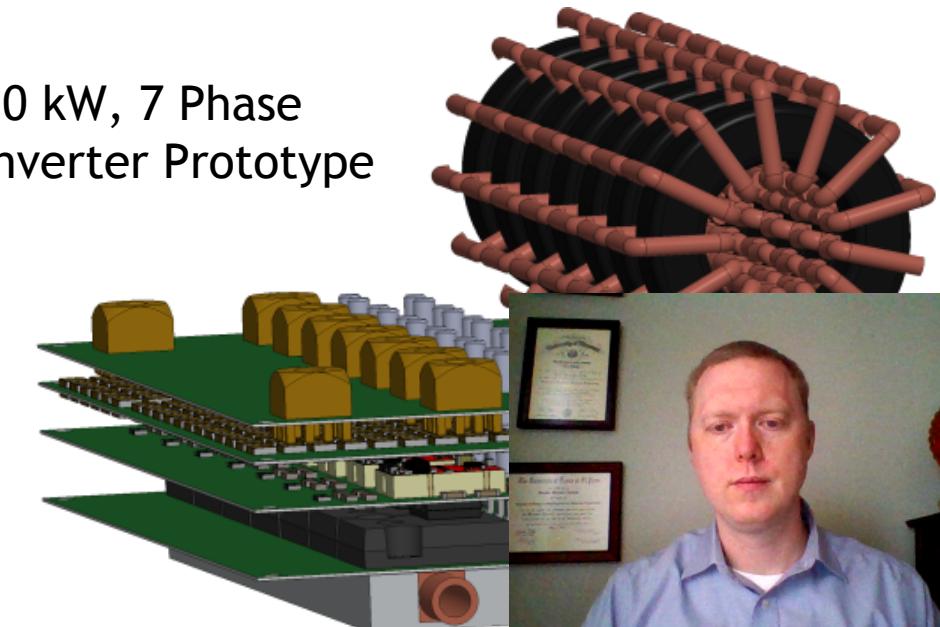


Parameter (gene)	Value
Vin	502 V
N Phase	7
Switching Frequency	46.5 kHz
Filter Inductance	16 $\mu$ H
DC Link	51 $\mu$ F

Module	Specifications	Power Loss	Estimated Volume	Actual Volume
DC Link	0.1 $\mu$ F (1808) X 512	-	19.3 mL	54.2 mL
Cooling	Cold Plate*	-	0.1218 mL*	53.14mL
Filter Inductors	0058326A2 (OD:3.5cm, HT:4cm)	185.97 W	272 mL	313.26 mL
Power Devices	1.2 kV SiC MOSFETs	408.5 W	12.8 mL	57.4 mL
Total	-	594.5 W	304.2 mL	478 mL
Remarks	-	$\eta=95.6\%$	*Possible error in cooling calculation	*Based on 3D rendering



10 kW, 7 Phase Inverter Prototype

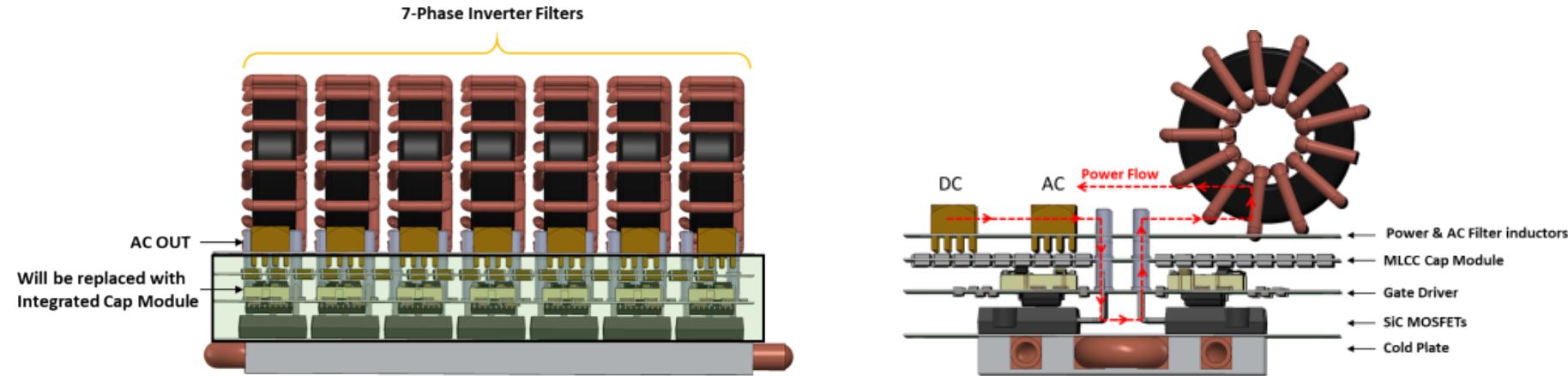


# Proposed Future Research



## Remaining FY21 Tasks

- Building and Testing Reduced Scale Prototypes
  - 10 kW peak (5.5 kW continuous) Inverter Drive
- Update Optimization to identify design for 100 kW peak, 55 kW continuous



## Research in FY22 and Beyond

- Co-Optimize inverter and Homo-Polar motor in development by Purdue University
- Build inverter exemplar using Sandia-developed GaN devices

\* Any proposed future work is subject to change based on funding



# Summary



- Advanced components are being developed to reduce the size of filters and thermal management components
- A research approach is identified to model, develop, and simulate power components and to optimize a power train design using multi-objective optimization tools
- This optimization approach enables a holistic-approach to the drive design
  - Design codes are first being developed to optimize candidate power electronic and motor designs separately; these will then be merged to co-optimize these two components
  - Each year, hardware prototypes will be developed to verify designs and recalibrate models
  - Sandia is working closely with Purdue; Purdue is focusing on the machine optimization
- Progress has been made on the development of modeling tools and advanced performance evaluation methods, i.e. MTBF calculation
- Candidate designs have been designed and built, focusing first on a boost converter. Control codes are being applied next to inverter drives
- Next steps will focus on building and testing inverter prototypes

